

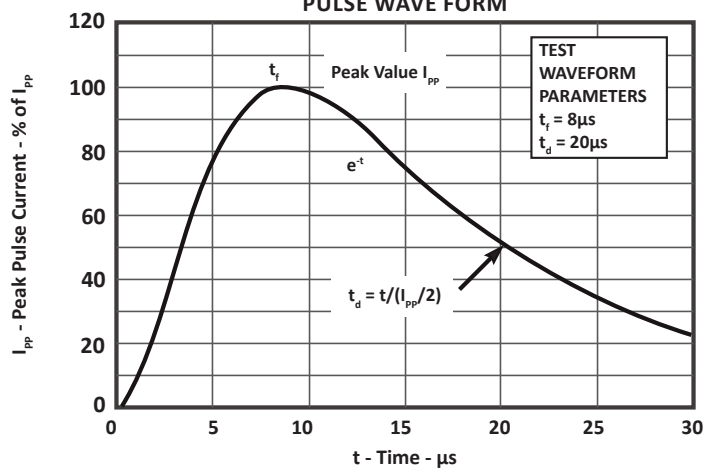
TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

| PARAMETER | SYMBOL | VALUE | UNITS |
|------------------------------|-----------|------------|-------|
| Operating Temperature | T_A | -55 to 150 | °C |
| Storage Temperature | T_{STG} | -55 to 150 | °C |
| Continuous Power Dissipation | P_{PC} | 145 | mW |

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

| PART NUMBER | DEVICE MARKING | REPETITIVE PEAK REVERSE VOLTAGE V_{RRM} VOLTS | TYPICAL FORWARD VOLTAGE @ 50mA V_F VOLTS | MAXIMUM PEAK PULSE FORWARD CURRENT @ 8/20μs I_{FM} AMPS | MAXIMUM REVERSE LEAKAGE CURRENT V_{RRM} @ 18V I_R nA | MAXIMUM QUIESCENT SUPPLY CURRENT @ 20V I_{RQ} nA | TYPICAL CAPACITANCE 0V, 1MHz C_J pF |
|-------------|----------------|---|---|--|---|---|--|
| DALC112S1 | PSC | 20 | 1.3 | 12 | 20 | 200 | 5 |

 FIGURE 1
 PULSE WAVE FORM


TYPICAL DEVICE CHARACTERISTICS

FIGURE 2
NON-REPETITIVE PEAK PULSE CURRENT CAPABILITY

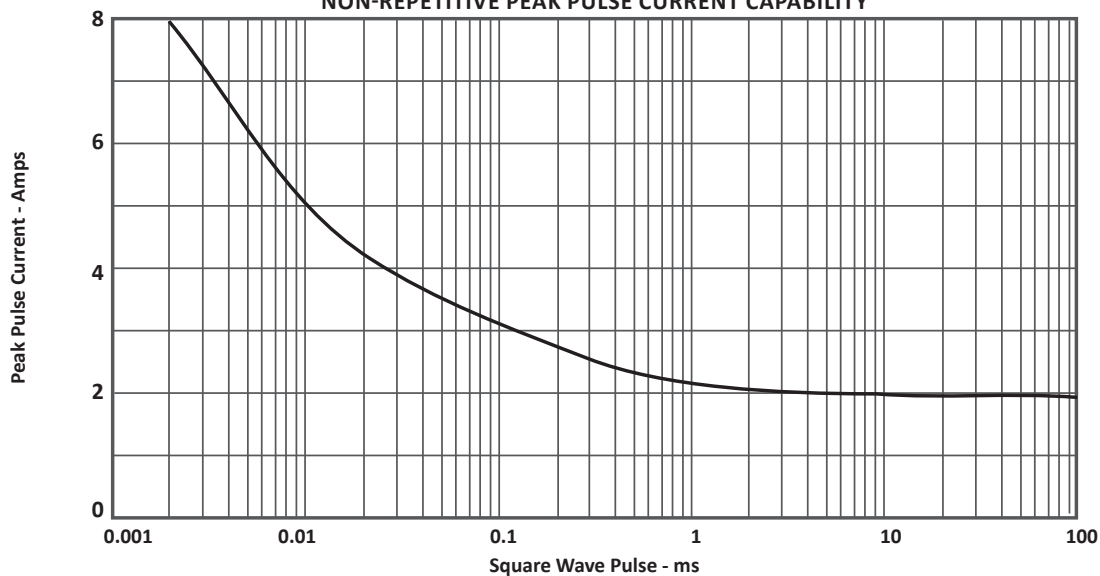


FIGURE 3
TYPICAL LOW CURRENT FORWARD VOLTAGE DROP

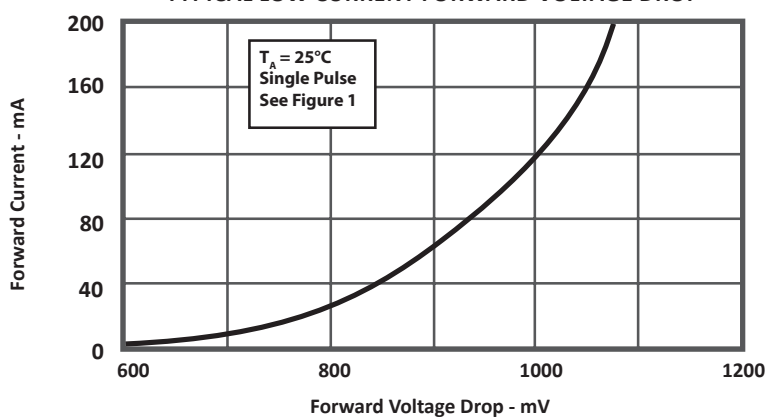
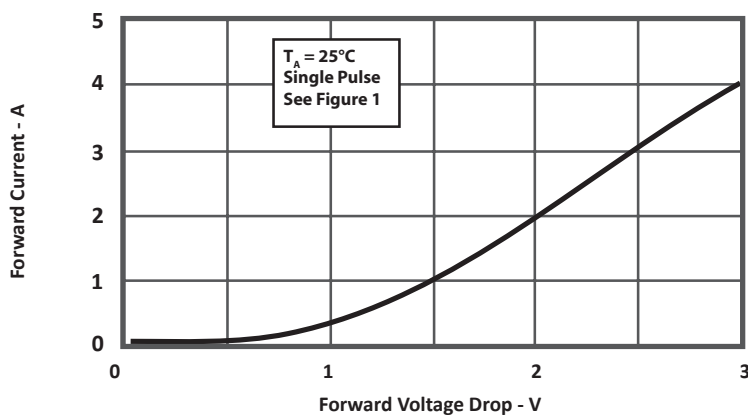


FIGURE 4
LOW FORWARD CURRENT VS FORWARD VOLTAGE

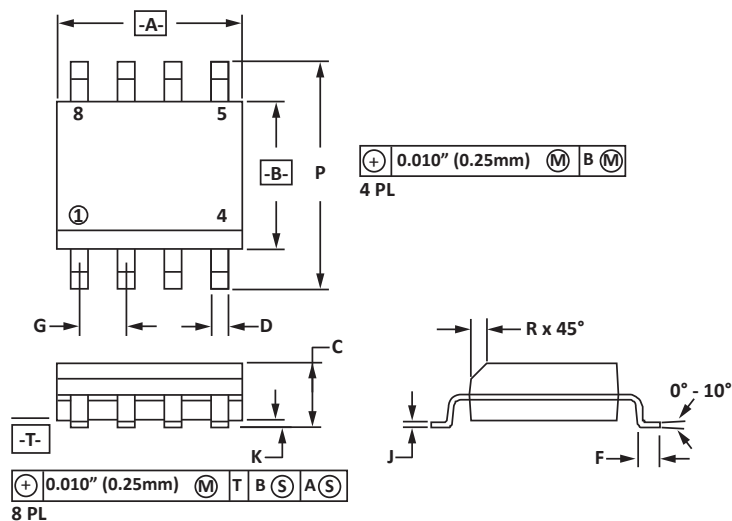


SO-8 PACKAGE INFORMATION

| OUTLINE DIMENSIONS | | | | |
|--------------------|-------------|------|----------|-------|
| DIM | MILLIMETERS | | INCHES | |
| | MIN | MAX | MIN | MAX |
| A | 4.80 | 5.00 | 0.189 | 0.196 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 BSC | | 0.05 BSC | |
| J | 0.18 | 0.25 | 0.007 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.008 |
| P | 5.80 | 6.20 | 0.229 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

NOTES

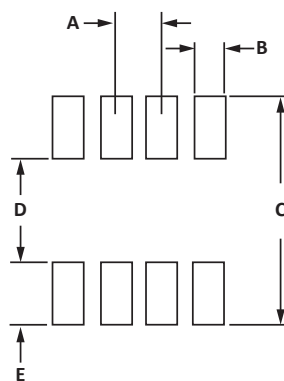
1. -T- = Seating plane and datum surface.
2. Dimensions "A" and "B" are datum.
3. Dimensions "A" and "B" do not include mold protrusion.
4. Maximum mold protrusion is 0.015" (0.380mm) per side.
5. Dimensioning and tolerances per ANSI Y14.5M, 1982.
6. Dimensions are exclusive of mold flash and metal burrs.



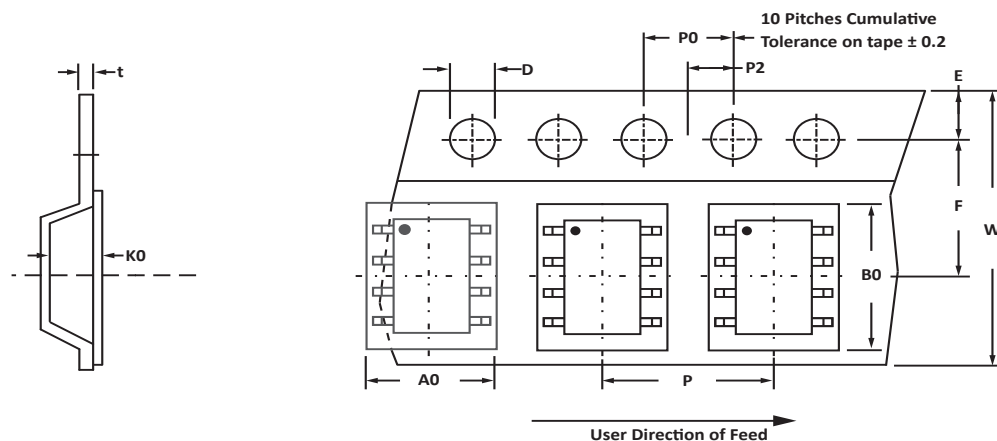
| PAD LAYOUT DIMENSIONS | | | | |
|-----------------------|-------------|------|--------|-------|
| DIM | MILLIMETERS | | INCHES | |
| | MIN | MAX | MIN | MAX |
| A | 1.14 | 1.40 | 0.045 | 0.055 |
| B | 0.64 | 0.89 | 0.025 | 0.035 |
| C | 6.22 | - | 0.245 | - |
| D | 3.94 | 4.17 | 0.155 | 0.165 |
| E | 1.02 | 1.27 | 0.040 | 0.050 |

NOTES

1. Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS

| REEL DIA. | TAPE WIDTH | A0 | B0 | K0 | D | E | F | W | P0 | P2 | P | tmax |
|------------|------------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|-------------|-------------|-------------|------|
| 178mm (7") | 12mm | 6.50 ± 0.10 | 5.40 ± 0.10 | 2.00 ± 0.10 | 1.50 ± 0.10 | 1.75 ± 0.10 | 5.50 ± 0.05 | 12.00 ± 0.30 | 4.00 ± 0.12 | 2.00 ± 0.10 | 8.00 ± 0.10 | 0.25 |

NOTES

- Dimensions are in millimeters.
- Surface mount product is taped and reeled in accordance with EIA-481.
- Suffix - T7 = 7" Reel - 1,000 pieces per 12mm tape.
- Suffix - T13 = 13" Reel - 2,500 pieces per 12mm tape.
- Bulk product shipped in tubes of 98 pieces per tube.
- Marking on Part - marking code (see page 2), date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION

| BASE PART NUMBER | LEADFREE SUFFIX | TAPE SUFFIX | QTY/REEL | REEL SIZE | TUBE QTY |
|------------------|-----------------|-------------|----------|-----------|----------|
| DALC112S1 | -LF | -T7 | 1,000 | 7" | 98 |
| DALC112S1 | -LF | -T13 | 2,500 | 13" | 98 |

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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